

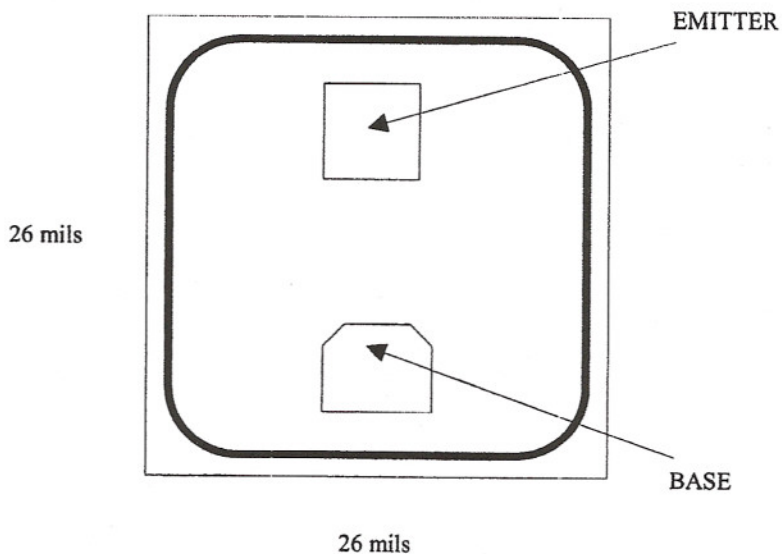


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Chip back potential is the level which bulk silicon is maintained by on-chip connection, or it is the level to which the chip back must be connected when specifically stated below. If no potential is given the chip back should be isolated.



CHIP BACK IS COLLECTOR

Top Material: AL
Backside Material: AU
Bond Pad Size: 5 MILS
Backside Potential: COLLECTOR
Mask Ref:

APPROVED BY:MG

DIE SIZE :26 x 26 MILS

DATE: 12/1/08

MFG: ZTX

THICKNESS: 6 MILS

P/N:ZTX550